

## NC-Cap/PSR™ (Primary Side Regulation) CV/CC Controller

### FEATURES

- ◆ Low Standby Power Under 30mW, Easily to Pass Energy Star EPS2.0
- ◆ Proprietary **NC-Cap/PSR™** (Primary Side Regulation) Control without External Compensation/Filtering Capacitor Needed
- ◆  $\pm 5\%$  Constant Current (CC) and Constant Voltage (CV) Regulation at Universal AC Input
- ◆ Proprietary Cable Voltage Drop Compensation in CV Mode
- ◆ Compensate for Line Voltage Variation
- ◆ Compensate for Transformer Inductance Tolerances
- ◆ Pins Floating Protection
- ◆ PFM Control Eases EMI Design
- ◆ Cycle-by-Cycle Current Limiting
- ◆ Built-in Leading Edge Blanking (LEB)
- ◆ Built-in Soft Start
- ◆ Output Over Voltage Protection
- ◆ VDD OVP & Clamp
- ◆ VDD Under Voltage Lockout (UVLO)

### APPLICATIONS

- ◆ Battery chargers for cellular phones, cordless phones, PDA, digital cameras, etc
- ◆ Replaces linear transformer and RCC SMPS
- ◆ Small power adapter
- ◆ AC/DC LED lighting

### GENERAL DESCRIPTION

SF5920 is a high performance, highly integrated DCM (Discontinuous Conduction Mode) Primary Side Regulation (PSR) controller for offline small power converter applications.

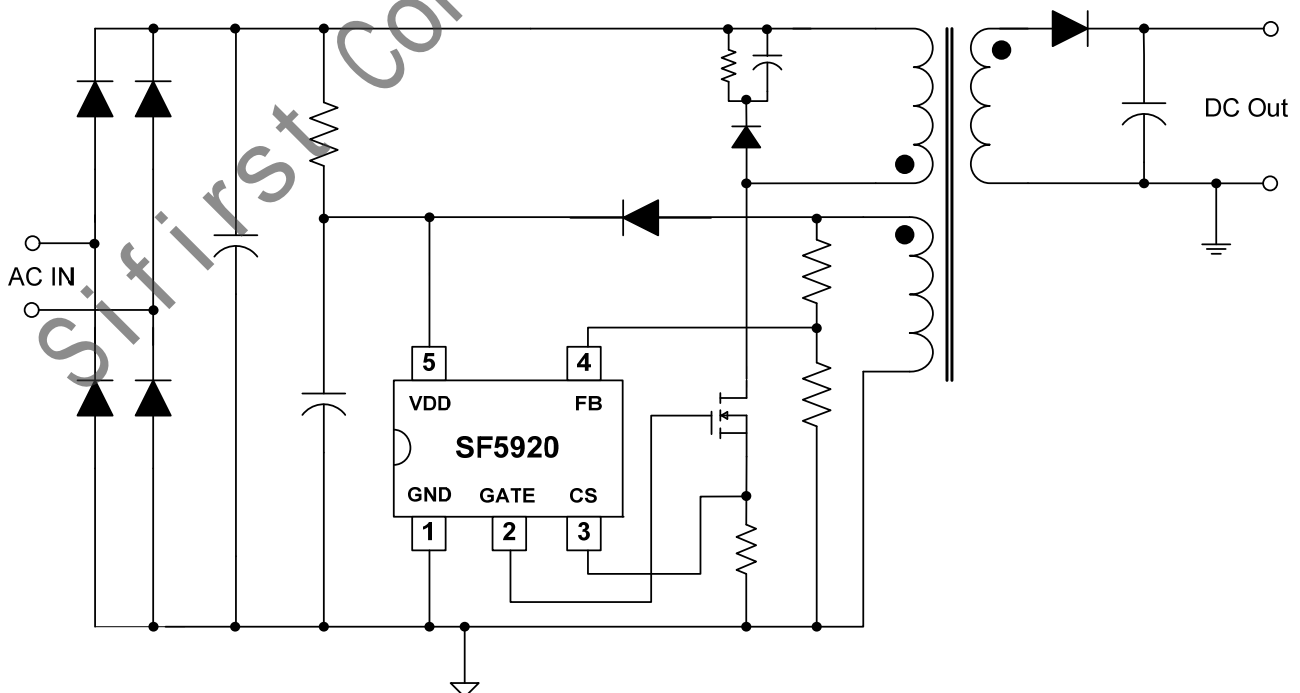
SF5920 uses Pulse Frequency Modulation (PFM) control to improve efficiency and eases system EMI design. The IC dramatically lowers system cost by eliminating the opto-coupler and secondary control circuits. It also can provide very tight output voltage regulation (CV), in addition to output current control (CC) ideal for charging applications.

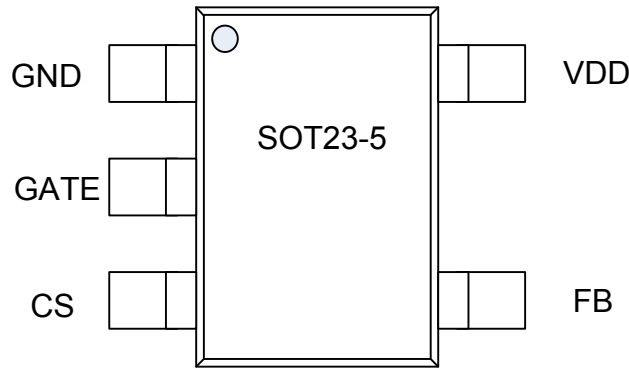
SF5920 has built-in proprietary **NC-Cap/PSR™** control for CV control, which eliminates external compensation or filtering capacitor. It also has built-in proprietary cable drop compensation function, which can provide excellent CV performance. The IC also has built-in soft start function to soften the stress on the MOSFET during power on period. Under light load conditions, the IC decreases switching frequency to achieve excellent regulation and high efficiency, yet meets the requirement for no-load consumption less than 30mW.

SF5920 integrates functions and protections of Under Voltage Lockout (UVLO), VDD Over Voltage Protection (VDD OVP), Output Over Voltage Protection (Output OVP), Soft Start, Cycle-by-cycle Current Limiting (OCP), Pins Floating Protection, Gate Clamping, VDD Clamping.

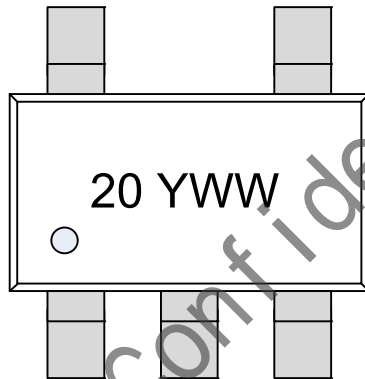
SF5920 is available in SOT23-5 package.

### TYPICAL APPLICATION



**Pin Configuration**

**Ordering Information**

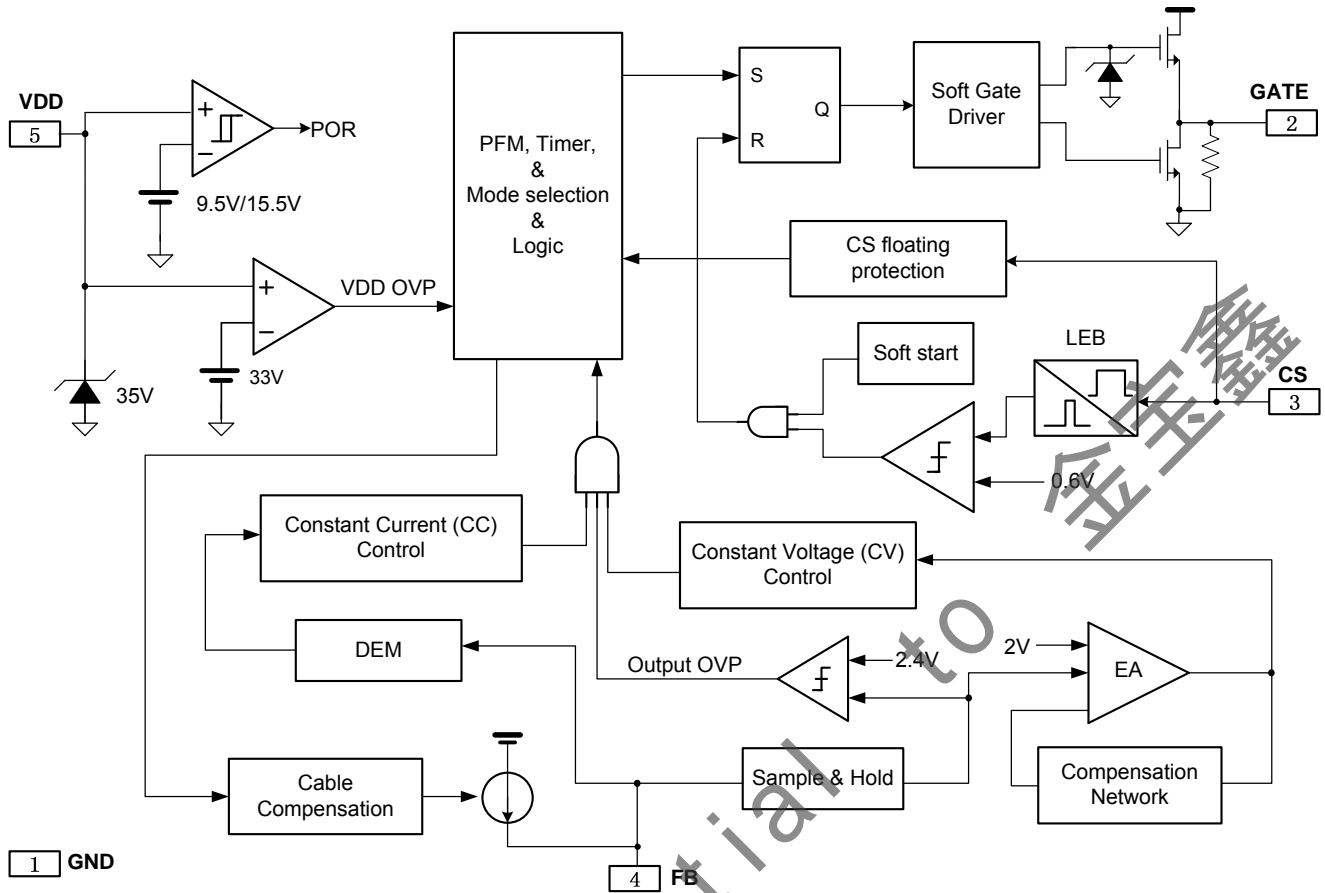
| Part Number | Top Mark | Package |       | Tape & Reel |
|-------------|----------|---------|-------|-------------|
| SF5920MGT   | .20YWW   | SOT23-5 | Green | Yes         |

**Marking Information**


Dot: Pin1 Mark  
YWW: Year & Week Code

**Pin Description**

| Pin Num | Pin Name | I/O | Description   |
|---------|----------|-----|---|
| 1       | GND      | P   | Ground  |
| 2       | GATE     | O   | Totem-pole gate driver output to drive the external MOSFET.   |
| 3       | CS       | I   | Current sense pin.  |
| 4       | FB       | I   | System feedback pin. This control input regulates both the output voltage in CV mode and output current in CC mode based on the flyback voltage of the auxiliary winding. |
| 5       | VDD      | P   | IC power supply pin.  |

**Block Diagram**

**Absolute Maximum Ratings (Note 1)**

| Parameter                              | Value      | Unit |
|--|------------|------|
| VDD DC Supply Voltage                  | 35         | V    |
| VDD DC Clamp Current                   | 10         | mA   |
| GATE pin                               | 20         | V    |
| FB, CS voltage range                   | -0.3 to 7  | V    |
| Package Thermal Resistance (SOT-23-5)  | 300        | °C/W |
| Maximum Junction Temperature           | 150        | °C   |
| Operating Temperature Range            | -40 to 85  | °C   |
| Storage Temperature Range              | -65 to 150 | °C   |
| Lead Temperature (Soldering, 10sec.)   | 260        | °C   |
| ESD Capability, HBM (Human Body Model) | 3          | kV   |
| ESD Capability, MM (Machine Model)     | 250        | V    |

**Recommended Operation Conditions (Note 2)**

| Parameter                     | Value     | Unit |
|-------------------------------|-----------|------|
| Supply Voltage, VDD           | 10 to 30  | V    |
| Operating Ambient Temperature | -40 to 85 | °C   |

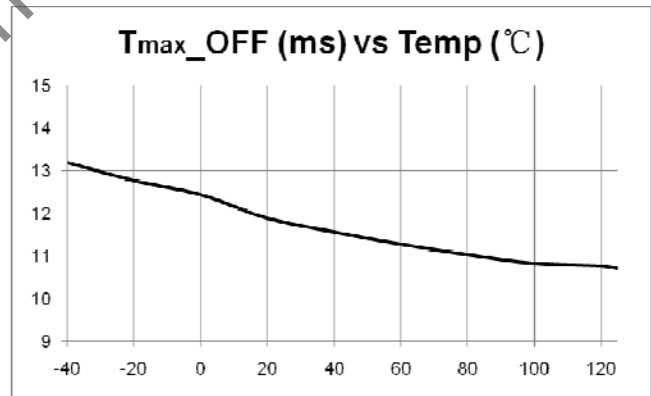
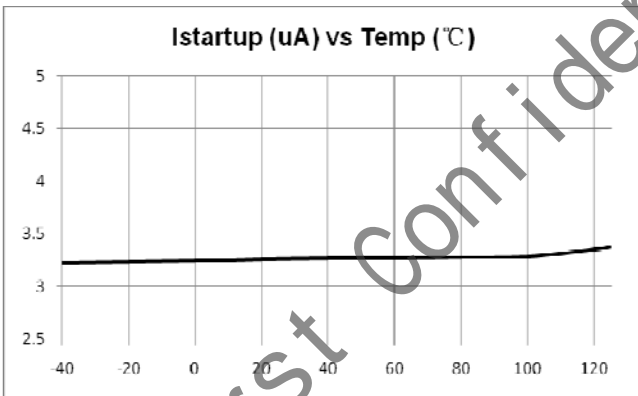
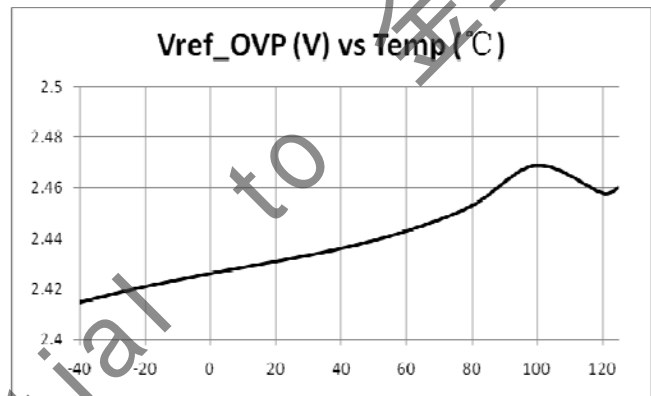
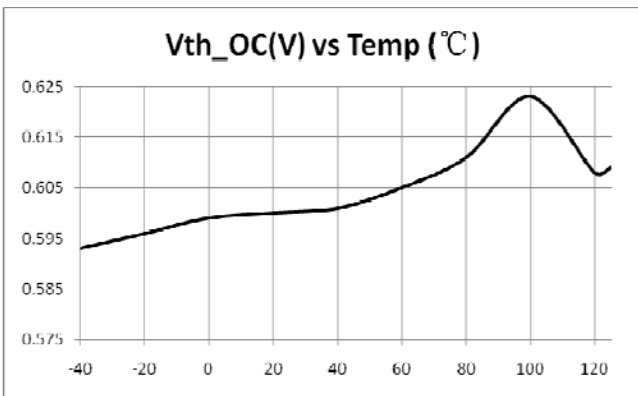
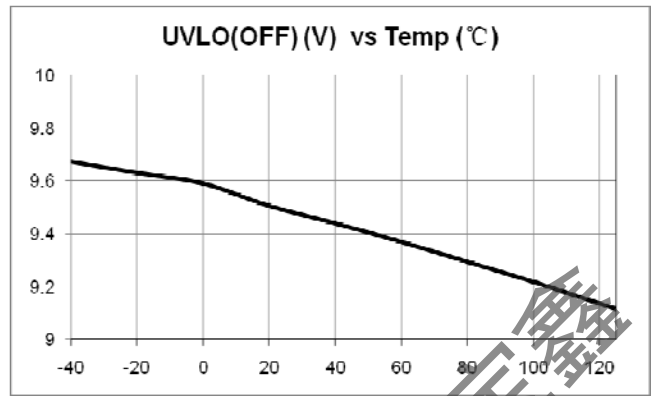
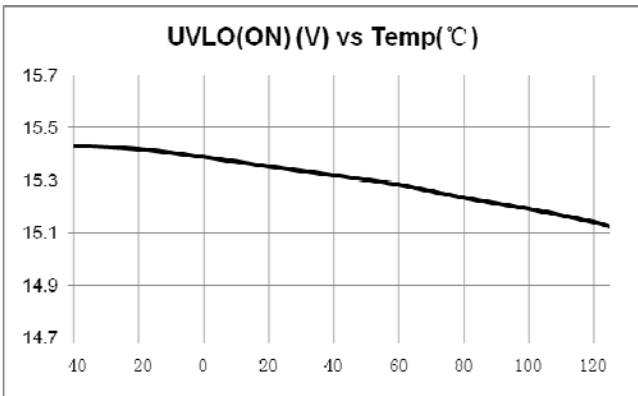
**ELECTRICAL CHARACTERISTICS**(T<sub>A</sub> = 25°C, VDD=16V, if not otherwise noted)

| Symbol                                      | Parameter   | Test Conditions                               | Min  | Typ  | Max  | Unit |
|---|---|---|------|------|------|------|
| <b>Supply Voltage (VDD) Section</b>         |   |   |      |      |      |      |
| I_Startup                                   | VDD Start up Current  | VDD =UVLO(ON)-1V,<br>Measure current into VDD |      | 5    | 20   | uA   |
| I_VDD_Op                                    | Operation Current   | V <sub>FB</sub> =3V,CL=1nF,<br>VDD=20V        |      | 1    | 1.5  | mA   |
| UVLO(ON)                                    | VDD Under Voltage<br>Lockout Exit (Startup)                                 |   | 14   | 15.5 | 16.5 | V    |
| UVLO(OFF)                                   | VDD Under Voltage<br>Lockout Enter  |   | 8.5  | 9.5  | 10.5 | V    |
| VDD_OVP                                     | VDD Over Voltage<br>Protection trigger                                      |   | 31   | 33   | 35   | V    |
| V <sub>DD</sub> _Clamp                      | VDD Zener Clamp<br>Voltage  | I(V <sub>DD</sub> ) = 10 mA                   | 33   | 35   | 37   | V    |
| T_Softstart                                 | Soft Start Time   |   |      | 2    |      | mSec |
| <b>Feedback Input Section(FB Pin)</b>       |   |   |      |      |      |      |
| V <sub>FB_EA_Ref</sub>                      | Internal Error<br>Amplifier(EA)<br>reference input                          |   | 1.97 | 2.0  | 2.03 | V    |
| V <sub>FB_OVP</sub>                         | Output over voltage<br>protection threshold                                 |   |      | 2.4  |      | V    |
| V <sub>FB_DEM</sub>                         | Demagnetization<br>comparator threshold                                     |   |      | 0.1  |      | V    |
| T <sub>min_OFF</sub>                        | Minimum OFF time  |   |      | 2    |      | uSec |
| T <sub>max_OFF</sub>                        | Maximum OFF time  |   |      | 12   |      | mSec |
| T <sub>CC</sub> /T <sub>DEM</sub>           | Ratio between<br>switching period in<br>CC mode and<br>demagnetization time |   |      | 2    |      |      |
| I <sub>Cable_max</sub>                      | Max Cable<br>compensation current   |   |      | 40   |      | uA   |
| <b>Current Sense Input Section (CS Pin)</b> |   |   |      |      |      |      |
| T <sub>blanking</sub>                       | CS Input Leading<br>Edge Blanking Time                                      |   |      | 500  |      | nSec |
| V <sub>th_OC</sub>                          | Current limiting<br>threshold   |   | 588  | 600  | 612  | mV   |
| T <sub>D_OC</sub>                           | Over Current<br>Detection and Control<br>Delay                              | CL=1nF at GATE,                               |      | 100  |      | nSec |
| <b>Gate Drive Output</b>                    |   |   |      |      |      |      |
| VOL   | Output Low Level  | I <sub>o</sub> = 20 mA (sink)                 |      |      | 1    | V    |
| VOH   | Output High Level   | I <sub>o</sub> = 20 mA (source)               | 7.5  |      |      | V    |
| V <sub>G</sub> _Clamp                       | Output Clamp Voltage<br>Level   | VDD=24V                                       |      | 16   |      | V    |
| T <sub>r</sub>                              | Output Rising Time  | CL = 1nF                                      |      | 700  |      | nSec |
| T <sub>f</sub>                              | Output Falling Time   | CL = 1nF                                      |      | 35   |      | nSec |

**Note 1.** Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Note 2.** The device is not guaranteed to function outside its operating conditions.

**CHARACTERIZATION PLOTS**



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**OPERATION DESCRIPTION**

SF5920 is a high performance, highly integrated DCM (Discontinuous Conduction Mode) Primary Side Regulation (PSR) controller working in PFM (Pulse Frequency Modulation) mode. The built-in high precision CV/CC control with high level protection features make it very suitable for offline small power converter applications.

**◆ PSR Technology Introduction**

Assuming the system works in DCM mode, the power transfer function is given by

$$P = \frac{\eta}{2} \times L_m \times I_{pk}^2 \times f_s = V_o \times I_o \quad (\text{Eq.1})$$

In the equation above, P is output power, Vo and Io are system output voltage and current respectively, η is system power transfer efficiency, Lm is transformer primary inductance, fs is system switching frequency, Ipk is primary peak current in a switching cycle. The following figure illustrates the waveform in a switching cycle.

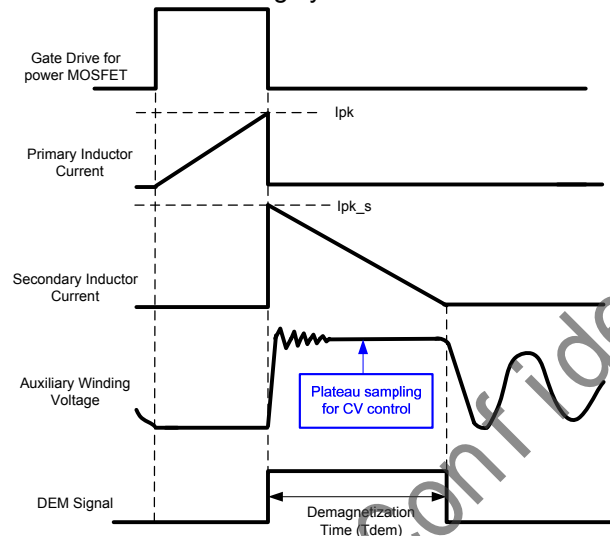


Fig.1

In the figure shown above, the IC generates a demagnetization signal (DEM) in each switching cycle through auxiliary winding. Tdem is demagnetization time for CV/CC control. In DCM mode, Tdem can be expressed as;

$$\frac{V_o}{L_m} \times T_{dem} = \frac{N_s}{N_p} \times I_{pk} \quad (\text{Eq.2})$$

In Eq.2, Np and Ns are primary and secondary winding turns respectively.

Combined with Eq.1 and Eq. 2, the average output current can be expressed as:

$$I_o = \frac{\eta}{2} \times I_{pk} \times \frac{N_p}{N_s} \times f_s \times T_{dem} \quad (\text{Eq.3})$$

**CC (Constant Current) Control Scheme**

From Eq.3, it can be easily seen that there are two ways to implement CC control: one is PFM (Pulse Frequency Modulation), the control scheme is to

keep Ipk to be constant, let the product of Ts and Tdem (fs\*Tdem) to be a constant. In this way, Io will be a value independent to the variation of Vo, Lm, and line input voltage. Another realization method is PWM duty control, the control scheme is to keep fs to be constant, let the product of Tdem and Ipk (Tdem\*Ipk) to be a constant, in another words, by modulating system duty cycle to realize a constant Io independent to the variation of Vo, Lm and line voltages.

SF5920 adopts PFM for CC control, the product of Ts and Tdem is given by

$$f_s \times T_{dem} = 0.5 \quad (\text{Eq.4})$$

**CV (Constant Voltage) Control Scheme**

CV control should sample the plateau of auxiliary winding voltage in flyback phase, as shown in Fig.1 The CV control has many implementations, for example, PWM, or PFM, or a combination of both one. In SF5920, the PFM control is adopted for CV control.

**◆ NC-Cap/PSR™ Eliminates External Compensation/Filtering Capacitor**

SF5920 uses a proprietary control to eliminate external compensation capacitor, which can simplify system design and lower system cost.

**◆ PFM Control Eases System EMI Design**

As mentioned above, the CC/CV control in SF5920 uses PFM control, which will ease system EMI design greatly. Since PFM control is a frequency variation system with inherent frequency shuffling function, it will have superior EMI performance than that of PWM control.

**◆ Precision CV/CC Performance with Smooth Transition between CV and CC**

In SF5920, the parameters is trimmed to tight range, which makes the system CC/CV to have less than 5% variation.

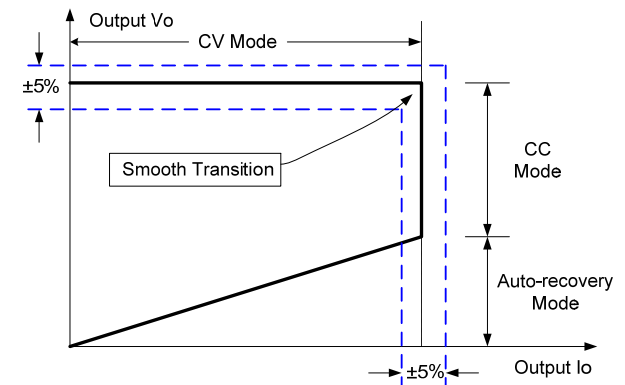


Fig.2

In SF5920, the IC has specially designed to be able to smoothly transit between CC and CV mode.

When the output voltage is too low, the IC will enter into auto-recovery mode, as shown in Fig. 2

◆ **Startup Current and Startup Control**

Startup current of SF5920 is designed to be very low (typically 5uA) so that VDD could be charged up above UVLO(ON) threshold level and device starts up quickly. A large value startup resistor can therefore be used to minimize the power loss yet reliable startup in application.

◆ **Operating Current**

The operating current in SF5920 is as small as 1mA (typical). The small operating current results in higher efficiency and reduces the VDD hold-up capacitance requirement. Once SF5920 enters very low frequency PFM mode, the operating current is reduced to less than 0.5mA, assisting the power supply in meeting power conservation requirements.

◆ **Soft Start**

SF5920 features an internal 2ms (typical) soft start that slowly increases the threshold of cycle-by-cycle current limiting comparator during startup sequence. It reduces the stress on the secondary diode during startup. Every startup process is followed by a soft start activation.

◆ **Proprietary Cable Voltage Drop Compensation in CV Mode**

When it comes to cellular phone charger applications, the battery is located at the end of cable, which causes typically several percentage of voltage drop on the actual battery voltage. SF5920 has a proprietary built-in cable voltage drop compensation block which can provide a constant output voltage at the end of the cable over the entire load range in CV mode.

◆ **Leading Edge Blanking (LEB)**

Each time the power MOSFET is switched on, a turn-on spike occurs across the sensing resistor. To avoid premature termination of the switching pulse, an internal leading edge blanking circuit is built in. During this blanking period (500ns, typical), the cycle-by-cycle current limiting comparator is disabled and cannot switch off the gate driver.

◆ **Minimum and Maximum OFF Time**

In SF5920, a minimum OFF time (typically 2us) is implemented to suppress ringing when GATE is off. The maximum OFF time in SF5920 is typically 10ms, which provides a large range for frequency reduction. In this way, a low standby power of 30mW can be achieved.

◆ **Pins Floating Protection**

In SF5920, if pin floating situation occurs, the IC is designed to have no damage to system.

◆ **Output OVP(Over Voltage Protection)**

In SF5920, the output OVP is integrated by plateau sampling the auxiliary winding in flyback phase. The threshold voltage for output OVP is 2.4V, as shown in Fig.3. Output OVP is auto-recovery mode protection (mentioned below).

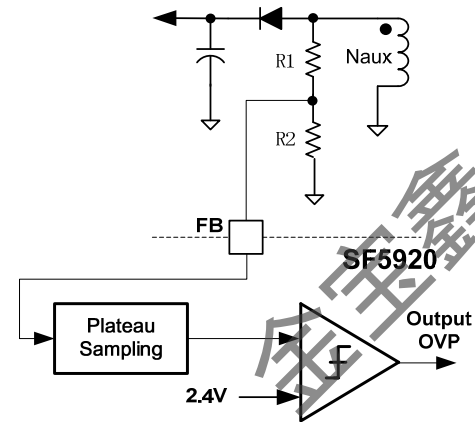


Fig.3

◆ **VDD OVP(Over Voltage Protection)**

VDD OVP (Over Voltage Protection) is implemented in SF5920 and it is a protection of auto-recovery mode.

◆ **Auto Recovery Mode Protection**

As shown in Fig.4, once a fault condition is detected, switching will stop. This will cause VDD to fall because no power is delivered from the auxiliary winding. When VDD falls to UVLO(off) (typical 9V), the protection is reset and the operating current reduces to the startup current, which causes VDD to rise, as shown in Fig.4. However, if the fault still exists, the system will experience the above mentioned process. If the fault has gone, the system resumes normal operation. In this manner, the auto restart can alternatively enable and disable the switching until the fault condition is disappeared.

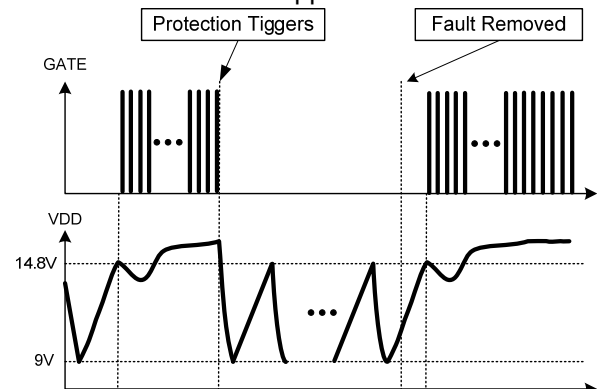
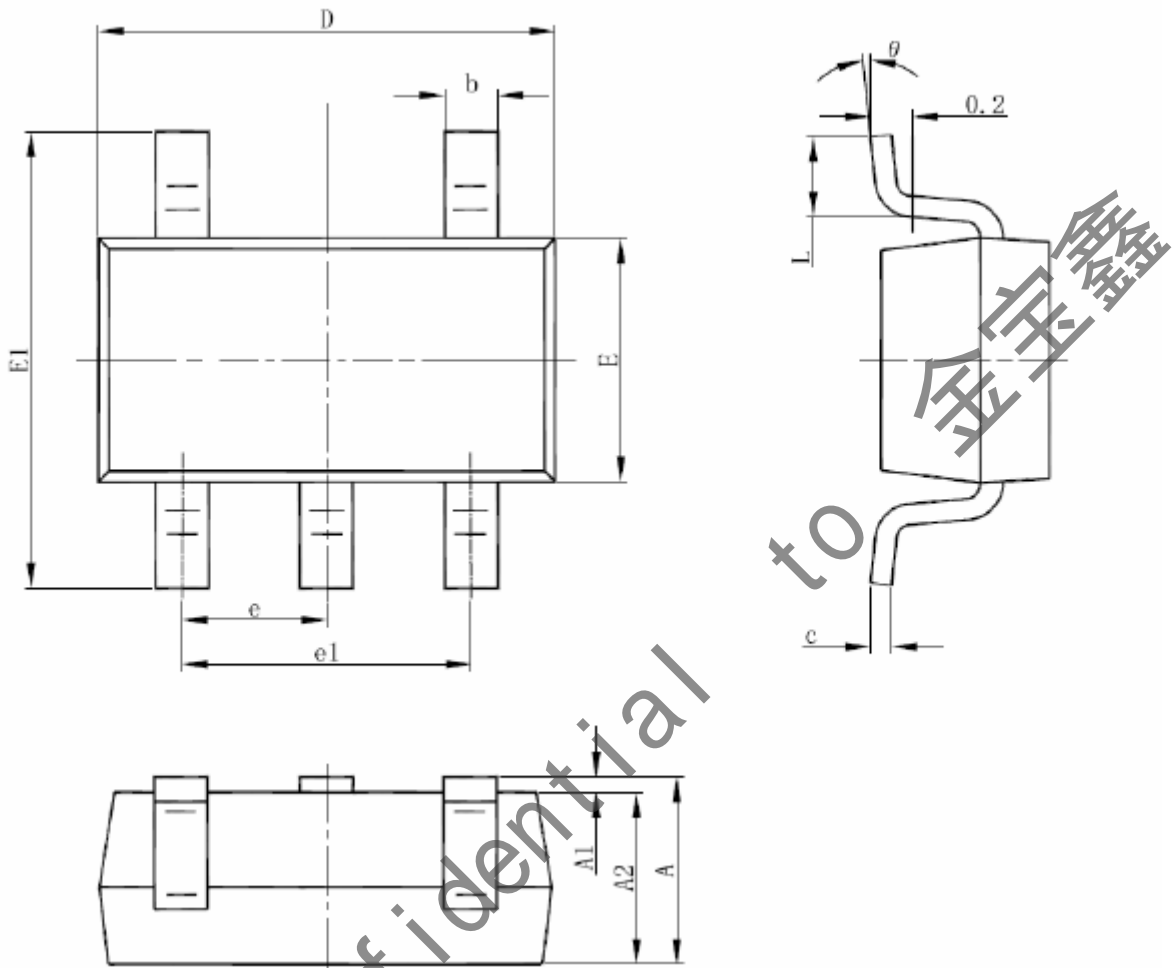


Fig.4

◆ **Soft Gate Drive**

SF5920 has a soft totem-pole gate driver with optimized EMI performance. An internal 17V clamp is added for MOSFET gate protection at higher than expected VDD input.



**PACKAGE MECHANICAL DATA**
**SOT-23-5L PACKAGE OUTLINE DIMENSIONS**


| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.050                     | 1.250 | 0.041                | 0.049 |
| A1     | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2     | 1.050                     | 1.150 | 0.041                | 0.045 |
| b      | 0.300                     | 0.500 | 0.012                | 0.020 |
| c      | 0.100                     | 0.200 | 0.004                | 0.008 |
| D      | 2.820                     | 3.020 | 0.111                | 0.119 |
| E      | 1.500                     | 1.700 | 0.059                | 0.067 |
| E1     | 2.650                     | 2.950 | 0.104                | 0.116 |
| e      | 0.950 (BSC)               |       | 0.037 (BSC)          |       |
| e1     | 1.800                     | 2.000 | 0.071                | 0.079 |
| L      | 0.300                     | 0.600 | 0.012                | 0.024 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |



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